In re Application of: Jarvis, 3 al.	**************************************	Group Art Unit:	1772
Serial No.: 09/828,715 <b>2007 &amp; 1</b>	OIPE)	Examiner: <u>J. Rh</u>	ee
Filed: April 6, 2001	SEP 2 3 2002	Our Account No.: 0	4-1403
Confirmation No.: 5602	A STATE OF A DESIGNATION OF THE PARTY OF THE		RECEIVED
Title: A Method of Joining Two or M a Seam	ore Substrates With )		SEP 2 6 2002
Commissioner for Patents		. •	TC 1700
U.S. Patent and Trademark Office Washington, DC 20231			10 1700
<u>AMENDMENT</u>			
This is a response/amendment/letter in the above-identified application and includes the herewith attachment of same date and subject which is incorporated hereinto by reference and the signature below is to be treated as the signature to the attachment in absence of a signature thereto.			
Fee requirements (if any) have been calculated as shown below:			
Claims	Highest	,	
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If amendment enters proper multiple dependent claim(s) into this application for first time, add			
\$270.00 (per application)			
Since Official Action set an original due date of citatal and N/A  PETITION is hereby made for an extension to cover the date this response is filed for which the			
requisite fee is enclosed (1 month \$110;	2 months \$400 3 months \$	esponse is filed for which the	
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[ ] herewith, enter one-half (1/2) of subt	otal and subtract	•	\$ <u></u>
	· TC	OTAL:	\$
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The Commissioner is hereby authorized to charge any fee specifically authorized hereafter, or any fees in addition to			
the fee(s) filed, or asserted to be filed, or which should have been filed herewith or concerning any paper filed			
nereafter, and which may be required under Rules 16-18 (deficiency only) now or hereafter relative to this application			
and the resulting official document under Rule 20, or credit any overpayment, to our Account No. shown in the heading			
hereof for which purpose a <u>duplicate</u> copy of this sheet is attached. This statement <u>does not authorize</u> charge of the <u>issue fee</u> in this case.			
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ADDRESS:	DORITY & MANNING	•	
Post Office Box 1449	ATTORNEYS AT LAW,	P.A.	•
Greenville, South Carolina 29602 Phone: 864-271-1592	By Atty: Jason W. Jo	hnston Reg. N	Vo.:45,675
Facsimile: 864-233-7342	Signature:	M	-
233-7342	Signature:	<del>M</del>	
I hereby certify that this correspondence and any referenced attachment and fee are being deposited with the United States Postal			
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Washington, DC 20231, on Septemb	per 18		· · · · · · · · · · · · · · · · · · ·
Lynn Watkins		• •	
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ATTORNEY DOCKET NO.: CX

NO.: CXU-359

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application )
Jarvis, et al. )
Serial No.: 09/828,715 )
Filed: April 6, 2001 )

Art Unit: 1772

Examiner: J. Rhee\*

Dept. Acct. No.: 04-1403

Title: A Method of Joining Two or More Substrates With a Seam

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SEP 2 6 2002

Commissioner of Patents Washington, D.C. 20231

TC 1700

## **AMENDMENT**

Dear Sir:

In response to the Office Action dated June 19, 2002, please amend the abovecaptioned application as follows:

## **IN THE CLAIMS:**

Please cancel claims 2-4 and 38-40.

Please amend claims 1, 19-20, 22, 26-27, 29, and 32-33 to read as follows (See also Appendix A):

1. (Amended) A method of forming a seam between substrates comprising: providing a first substrate having an upper surface and a lower surface, said upper and said lower surfaces of said first substrate defining at least one edge; providing a second substrate having an upper surface and a lower surface, said upper and said lower surfaces of said second substrate defining at least one edge;

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